SPECIFICATIONS			
CUSTOMER  SAMPLE CODE (Ver.)  MASS PRODUCTION CODE  DRAWING NO. (Ver.)	(Ver.)	PE-04011-005	F-018HY1Q(Ver.0) 5 (Ver.0)
	Custon	mer Approved	Date:
Ammonod		C Confirmed	Dorignou

Approved	QC Confirmed	Designer
2400		在,就度力206

- Approval For Specifications Only.
  - \* This specification is subject to change without notice.

Please contact Powertip or it's representative before designing your product based on this specification.

Approval For Specifications and Sample.

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# **RECORDS OF REVISION**

Date	Rev.	Description	Note	Design by
2006/7/21	0	PE12864WRF-018HY1Qis the ROHS compliant part number based on Powertip's standard PE12864WRF-018-HY1	-	

Total: 27 Page



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Note: For detailed information please refer to IC data sheet: NOVATEK---NT7532H-BDT



## 1. SPECIFICATIONS

## 1.1 Features

Item	Standard Value
Display Type	128 * 64 Dots
LCD Type	FSTN, White Positive, Transflective Extended temp
Driver Condition	LCD Module :1/65 Duty, 1/9 Bias
Viewing Direction	6 O'clock
Backlight	LED B/L
Weight	12 g
Interface	8 bits parallel data input
Other(controller/driver IC) NT7532H-BDT	
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news/LatestNews.asp

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	80.5 (W) ×45.0 (H) × 5.3 Max (T)	mm
Viewing Area	60.0 (W) * 32.6 (L)	mm
Active Area	55.01(W) * 27.49 (L)	mm
Dot Size	0.4 (W) × 0.4 (H)	mm
Dot Pitch	0.43 (W) × 0.43 (H)	mm

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	$V_{ m DD}$	-	-0.3	3.6	V
LCD Driver Supply Voltage	Vo -V <sub>SS</sub>	-	-0.3	14	V
Input Voltage	$V_{IN}$	-	-0.3	V <sub>DD</sub> +0.3	V
Operating Temperature	$T_{OP}$	-	-20	70	°C
Storage Temperature.	$T_{ST}$	-	-30	80	°C
Storage Humidity	$H_D$	Ta < 40 °C	-	90	%RH



## 1.4 DC Electrical Characteristics

 $V_{DD} = 2.85 \text{ V} \pm 0.3 \text{V}, V_{SS} = 0 \text{V}, \text{Ta} = 25^{\circ}\text{C}$ 

Item	Symbol	Condition	$\begin{array}{ c c c c c }\hline Min. \end{array}$	Тур.	Max.	Unit
Logic Supply Voltage	$ m V_{DD}$	-	2.55	2.85	3.15	V
"H" Input Voltage	V <sub>IH</sub>	-	0.8 Vdd	-	V <sub>DD</sub>	V
"L" Input Voltage	$V_{IL}$	-	Vss	-	0.2 Vdd	V
"H" Output Voltage	$V_{\mathrm{OH}}$	-	0.8 Vdd	-	$V_{\mathrm{DD}}$	V
"L" Output Voltage	$V_{\mathrm{OL}}$	-	Vss	-	0.2 Vdd	V
Supply Current	$I_{DD}$	$V_{DD} = 2.85 \text{ V}$	-	0.5	1.5	mA
		V0-V <sub>SS</sub> (-20°C)	-	1	-	
LCM Driver Voltage	$V_{\mathrm{OP}}$	V0–V <sub>SS</sub> (25°C)	7.7	8.0	8.3	V
		V0–V <sub>SS</sub> (70°C)	-	-	-	

# 1.5 Optical Characteristics

LCD Panel: 1/65 Duty, 1/9 Bias,  $V_{LCD} = 8.23$  V, Ta = 25°C

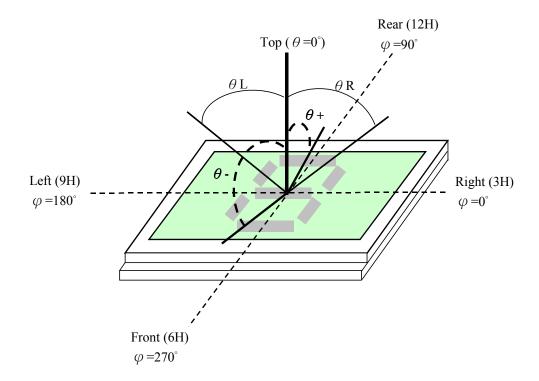
Item	Symbol	Conditions	Min.	Тур.	Max.	Reference
View Angle	ew Angle $\theta$ C $\geq$ 2.0, $\varnothing$		-40°	-	-	Notes 1 & 2
Contrast Ratio	CR	θ= -5°, Ø=270°	6	8	-	Note 3
Response Time(rise)	Tr	θ= -5°, Ø=270°	-	110 ms	165 ms	Note 4
Response Time(fall)	Tf	θ= -5°, Ø=270°	-	260 ms	390 ms	Note 4



#### Note 1.

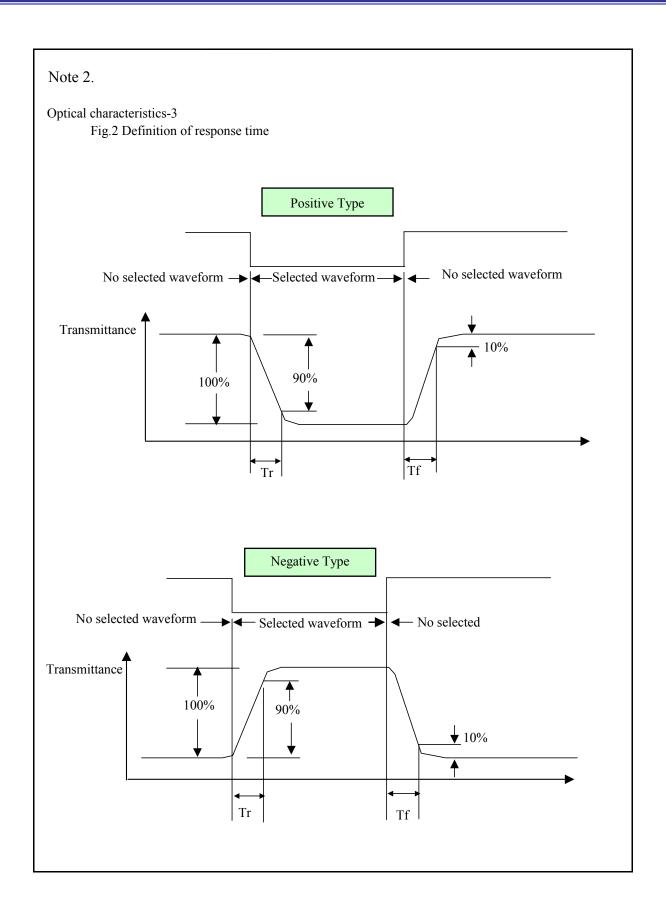
Optical characteristics-2

Viewing angle



Viewing angle







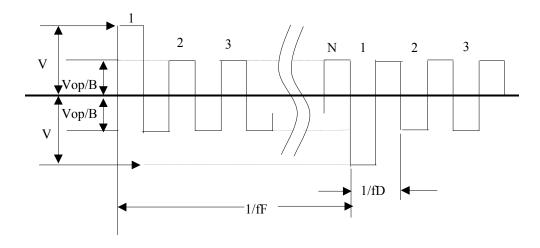
#### Electrical characteristics-2

**※**2 Drive waveform

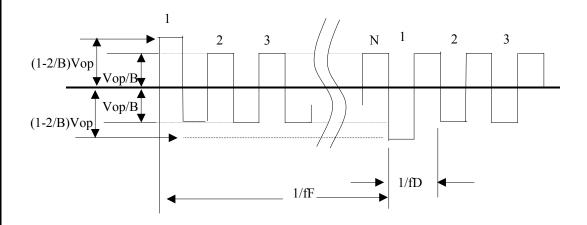
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

#### (1) Selected waveform



#### (2) Non- Selected waveform

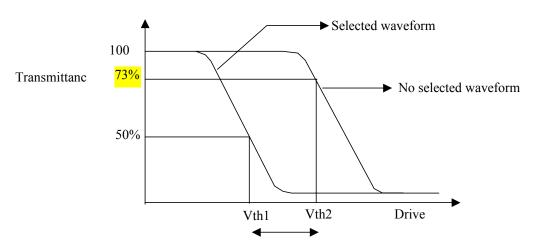


Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period



Note 3.: Definition of Vth



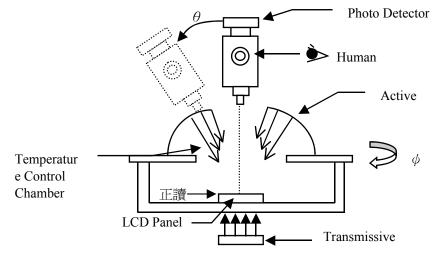
Active voltage range

	Vth1	Vth2
View direction	10°	$40\degree$
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

★1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System





# 1.6 Backlight Characteristics

LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Forward Current	IF	Ta = 25 °C	-	160	mA
Reverse Voltage	VR	Ta = 25 °C	-	1	V
Power Dissipation	PO	Ta = 25 °C	-	0.56	W
Operating Temperature	$T_{OP}$	-	-30	70	$^{\circ}\mathbb{C}$
Storage Temperature	$T_{ST}$	-	-40	80	$^{\circ}\!\mathbb{C}$
Solder Temp. for 3 Second	-	-	260		$^{\circ}\!\mathbb{C}$

# Electrical / Optical Characteristics

Ta =25°C

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF	IF = 40mA	-	3.5	-	V
Reverse Current	IR	VR= 0.8 V	-	-	30	mA
Average Brightness (without LCD) *1	IV	IF = 40 mA	96	128	-	cd/m <sup>2</sup>
CIE Color Coordinate	X	IE = 40m A	0.17	-	0.22	-
(with LCD) *1	Y	IF = 40 mA	0.1-2	-	0.18	-
Color	White					

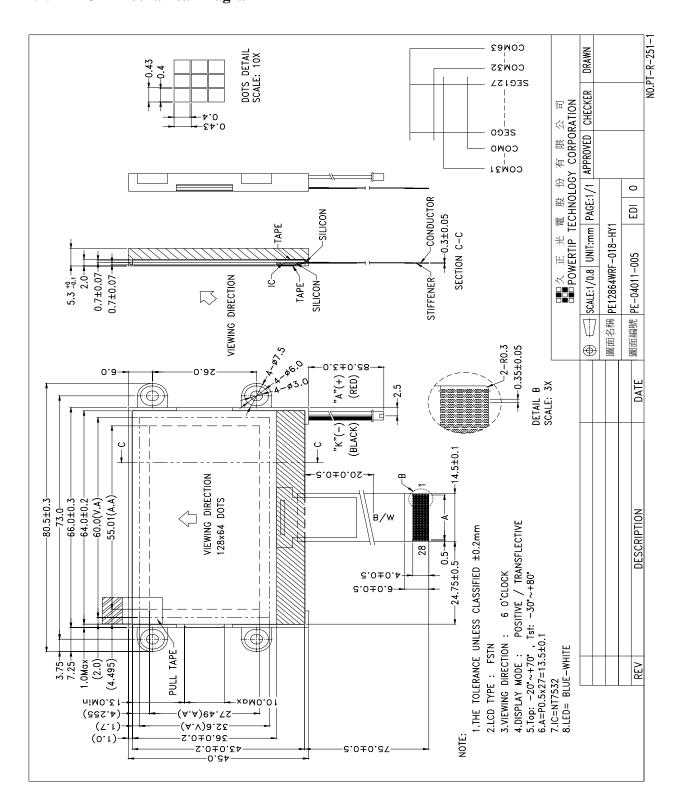
<sup>\*1</sup> This vaule will be changed while mass production.



## 2. MODULE STRUCTURE

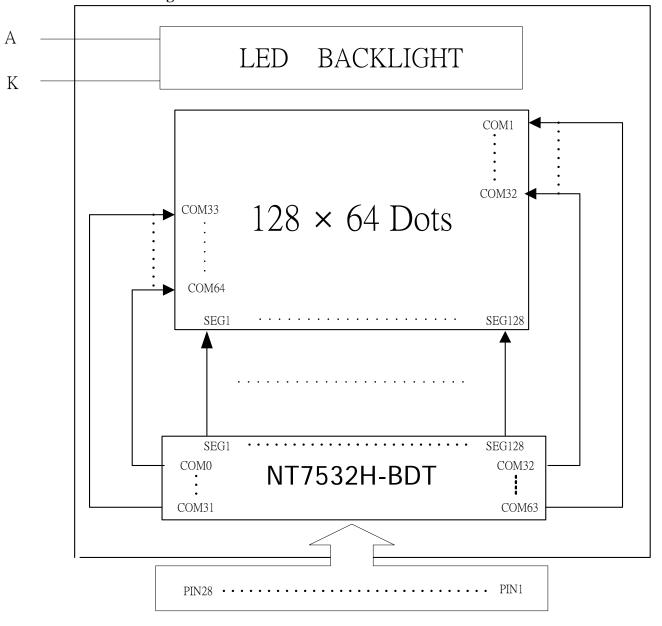
# 2.1 Counter Drawing

#### 2.1.1 LCM Mechanical Diagram





#### 2.1.2 Block Diagram



Prese refer interface pin description for detail



# 2.2 Interface Pin Description

Pin No.	Symbol	Function				
1	CS1	This is the chip select signal. When CS1 = "L" then the chip select				
1	CSI	becomes active, and data/command I/O is enabled.				
2	/RES	/RES is set to "L", the settings are initialized.				
	/KLS	The /RES signal level performs the reset operation.				
		This is connect to the least significant bit of the normal MPU address				
3	A0	bus, and it determines whether the data bits are data or a command.				
	110	A0 = "H": Indicates that DB0 to DB7 are display data.				
		A0 = "L": Indicates that DB0 to DB7 are control data.				
		• When connected to an 8080 MPU, this is LOW active. This terminal				
4	/WR	connects to the 8080 MPU /WR signal. The signals on the data bus				
		are latched at the rising edge of the/ WR signal.				
		• When connected to an 8080 MPU, this is LOW active. This pin is				
5	/RD	connected to the /RD signal of the 8080 MPU, and the NT7532 series				
		data bus is in an output status when this signal is "L".				
6	DB0					
7	DB1	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16-bit				
8	DB2	standard MPU data bus.  When the serial interface is selected (P/S = "L"), DB7 serves as the				
9	DB3	serial data input terminal (SI) and DB6 serves as the serial clock input				
10	DB4	terminal (SCL).				
11	DB5	At the same time, DB0 to DB5 are set to high impedance. When the				
12	DB6	chip select is inactive, DB0 to DB7 are set to high impedance				
13	DB7					
14	$V_{DD}$	Power Supply (V <sub>DD</sub> =2.85V)				
15	$V_{SS}$	Power Supply (V <sub>SS</sub> =0)				
16	VOUT	DC/DC voltage converter output				
17	CAP3+	Capacitor 3+ pad for internal DC/DC voltage converter				
18	CAP1-	Capacitor 1- pad for internal DC/DC voltage converter				
19	CAP1+	Capacitor 1+ pad for internal DC/DC voltage converter				

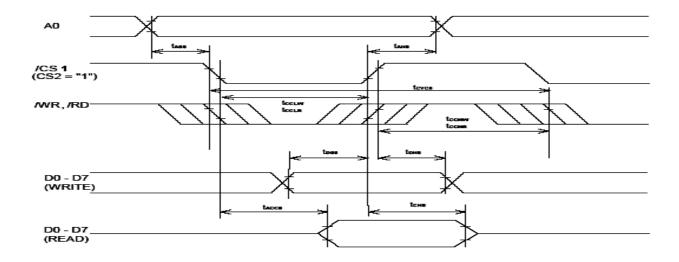


20	CAP2+	Capacitor 2+ pad for internal DC/DC voltage converter
21	CAP2-	Capacitor 2- pad for internal DC/DC voltage converter
22	V1	LCD driver supply voltages
23	V2	The voltage determined by LCD cell is cell impedance-converted by a resistive driver or an operational amplifier for application. Voltages
24	V3	should be according the following relationship;  V0 V1 V2 V3 V4 VSS
25	V4	When the internal power circuit is active, these voltages are generated
26	V0	as following table according to the state of LCD Bias command.
27	LCD_ID	no connection
28	IRS	This terminal selects the resistors for the V0 voltage level adjustment.  IRS = "H": Use the internal resistors.  IRS = "L": Do not use the internal resistors.  The V0 voltage level is regulated by an external resistive  Voltage divider attached to the VR terminal. This pin is  Enabled only when the master operation mode is selected  It is fixed to either "H" or "L" when the slave operationmode  Is selected

A	+	Power supply LED backlight anode input(+)
K	-	Power supply LED backlight cathode input(-)



## 2.3 Timing Characteristics



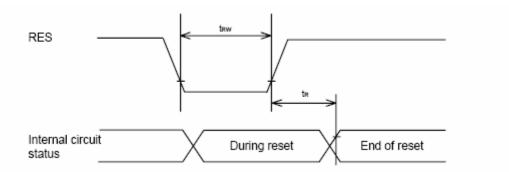
 $(V_{DD} = 2.7 \text{ to } 3.0 \text{ V})$ 

						( T D D 2.7 to 3.0 T)
Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Address hold time	tah8	0				
Address setup time	tas8	0				
System cycle time	tcyc8	300				
Control L pulse width (/WR)	tcclw	90				
Control L pulse width (/RD)	tcclr	120			ns	
Control L pulse width (/WR)	tcchw	120			113	
Control L pulse width (/RD)	<b>t</b> cchr	60				
Data setup time	tds8	40				
Data hold time	t <sub>DH8</sub>	15				
/RD access time	tacc8			140		$C_L = 100 pf$
Output disable time	tch8	10		100		C <sub>L</sub> = 100pf

- \*1. The input signal rise time and fall time (tr,tf) is specified at 15ns or less. When the system cycle time is extremely fast,(tr+tf) $\leq$ (tcyc8-tcclw-tcchw) for (tr+tf)  $\leq$ (tcyc8-tcclr-tcchr) are specified.
- \*2. All timing is specified using 20% and 80% of VDD as the reference.
- \*3. tccLw and tccLR are specified as the overlap between CS1 being "L" and /WR and /RD being at the "L"level.



# **Reset Timing**



 $(V_{DD} = 2.7 \text{ to } 3.0 \text{ V})$ 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Reset time	tr			1.0	us	
Reset low pulse width	trw	1.0				



# 2.4 Display Command

Command				(	Comi	nand	Cod	e				Function
Command	A0	RD	WR	D7	D6	D5	D4	D3	D2	D2	D0	runction
(1) Digmley ON/OFF	0	1	0	1	0	1	0	1	1	1	0	LCD display ON/OFF
(1) Display ON/OFF											1	0:OFF, 1:ON
(2) Disulant start line and	0	1	0	0	1	1	D:1	4	1	1.1		Sets the display RAM display
(2) Display start line set	0	1	0	0	1	1	Jispi	ay su	art ad	iaress	6	start line address
(2) Page address set	0	1	0	1	0	1	1	р		ماماسم		Sets the display RAM page
(3) Page address set	U	1	0	1	U	1	1	Ρ	age a	aare	SS	address
(4) Colonia (11)								Mo	at aic	mific	ont	Sets the most significant 4 bits of
(4) Column address set upper bit	0	0 1 0 0 0 0 1 Most significant column address			the display RAM column							
upper on								COI	umm	auui	CSS	address.
Column address set								Les	ıst sig	mific	ant	Sets the least significant 4 bits of
Column address set lower bit	0	1	0	0	0	0	0		umn			the display RAM column
10 Wei oit								COI	umm	auur		address.
(5) Status read	0	0	1		Sta	itus		0	0	0	0	Reads the status data
(6) Display data write	1	1	0			,	Write	data	l			Writes to the display RAM
(7) Display data read	1	0	1			1	Read	l data				Reads from the display RAM
(0) 47 G	0	1	0	1	0	1	0	0	0	0	0	Sets the display RAM address
(8) ADC select											1	SEG output correspondence 0: normal, 1: reverse
	0	1	0	1	0	1	0	0	1	1	0	Sets the LCD display RAM
(9)Display normal/	U	1	0	1	U	1	0	0	1	1	U	normal/reverse
reverse											1	0: normal, 1: reverse
(10) Display all points	0	1	0	1	0	1	0	0	1	0	0	Display all points
ON/OFF											1	0: normal display, 1: all points ON
	0	1	0	1	0	1	0	0	0	1	0	Sets the LCD drive voltage bias
(11) LCD bias set	U	1	U	1	U	1	U	U	0	1		ratio
											1	0: 1/9, 1:1/7
(12) D 1/ 1:0 / :	0	1	0	1	1	1					_	Column address increment
(12) Read/modify/write	0	1	0	1	1	1	0	0	0	0	0	At write: +1 At read: 0
(13) End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write
				_		_ 1		_				Clour roughirounty/ write
(14) Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset



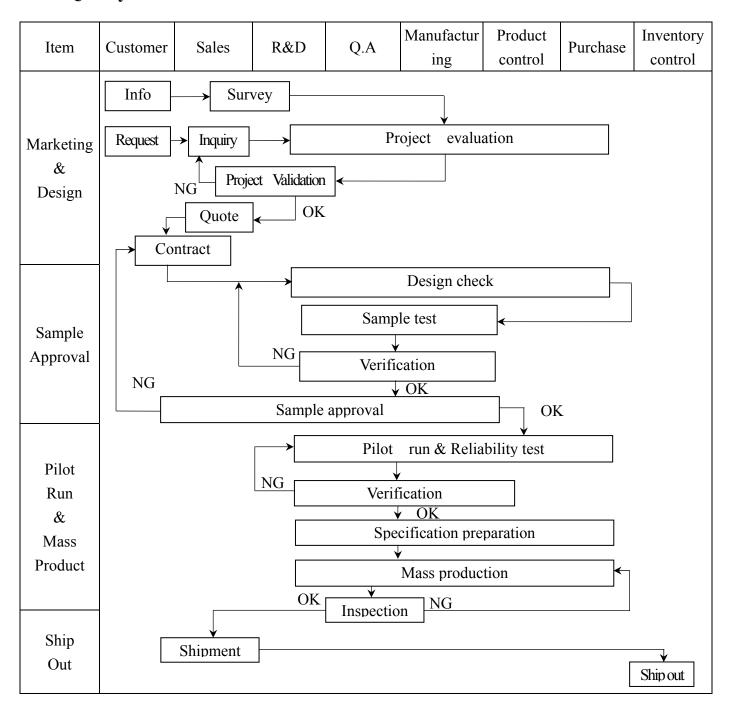
(15) Common output	0	1	0	1	1	0	0	0	*	*	*	Select COM output scan direction
mode select								1				0: normal direction, 1: reverse direction
(16) Power control set	0	1	0	0	0	1	0	1	Operating mode		_	Select internal power supply operating mode
(17) V5 voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Resistor ratio		ratio	Select internal resistor ratio (Rb/Ra) mode
(18) Electronic volume mode set	0	1	0	1	0	0	0	0	0 0 1		1	
Electronic volume register set	0	1	0	*	*	El	ectro	nic v	volume value			Set the V5 output voltage electronic volume register.
(19) Static indicator ON/OFF	0	1	0	1	0	1	0	1	1	0	0	0: OFF 1: ON
Static indicator register set	1	0	1	*	*	*	*	*	*	Mo	ode	Set the flashing mode
(20) Power saver												Display OFF and display all points ON compound command
(21) NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation
(22) Test	0	1	0	1	1	1	1	*	*	*	*	Command for IC test. Do not use this command

(Note) \*: disabled data

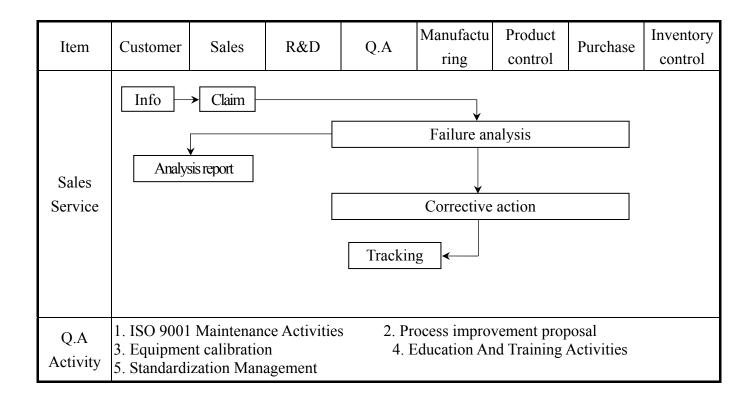


## 3. QUALITY ASSURANCE SYSTEM

## 3.1 Quality Assurance Flow Chart









## 3.2 Inspection Specification

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample

◆Defect Level: Major Defect AQL 0.4; Minor Defect AQL 1.5.

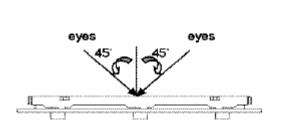
♦OUT Going Defect Level: Sampling.

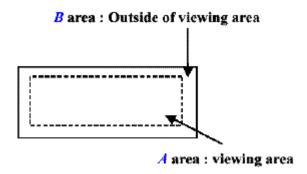
◆Manner of appearance test:

(1). The test be under 40W×2 fluorescent light 'and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line. (Fig. 1)

(3). Definition of area . (Fig. 2)





#### ◆ Specification:

NO	Item	Criterion	level
		1.1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1.2 Mixed production types.	Major
		1.3 Assembled in inverse direction.	Major
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
		4.1 Missing line character \ dot and icon.	Major
		4.2 No function or no display.	Major
04	Electrical Testing	4.3 Output data is error.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major
05	Black or white dot \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	<ul> <li>5.1 Round type:</li> <li>5.1.1 display only:</li> <li>• White and black spots on display ≤ 0.25mm, no more than Four white or black spots present.</li> <li>• Densely spaced: NO more than two spots or lines within 3mm</li> </ul>	Minor



◆Specification:

	ecification:	Criterion								1arva1
NO 05	Item	Criterion	1							level
03	Black or white dot \( \cdot \) scratch \( \cdot \)	5.1.2 N								
	contamination		Dim	ension (diameter	:Ф)	Acceptan	ce(Q'1	(y)		
	Round type			$\Phi \leq 0.10$ mm		Accept no de	nse			
	$\rightarrow$ <sub>X</sub> $\mid \leftarrow$ <sub>⊥</sub>		0.1	$0 \text{mm} < \Phi \leq 0.20 \text{m}$	nm		3			
	Y		0.2	$0$ mm $< \Phi \le 0.25$	nm		2			
	*			Total			4			
	$\Phi = (x+y)/2$	5.1.3 Li				1 .		(02)		Minor
				on (diameter : $\Phi$ )				ce (Q'ty)		
		Lengtl	h	width		A area		B area		
	+	I < 2.0		$w \le 0.03$ mm	0.5	Accept no de	ense	Don't cour		
	~ <b>√</b> ‡™	L≦3.0r		$0.03$ mm $< \Phi \le 0$		4		Don't cour		
	→ , ←	L≦2.5r	nm	$\frac{0.05\text{mm} < \Phi \leq 0}{2.05\text{mm}}$				Don't cour	ΙŪ	
				w>0.075mi	n	AS	s round	d type		
										_
						<u> </u>	(02)	\	_	
					A	Acceptan	ce(Q1	* /		
		Dimens	sion (	diameter : $\Phi$ )	A	area		B area		
			Φ≤	0.20mm	Acc	cept no dense		Don't count		
0.6	Polarizer	0.201		$\Phi \leq 0.50$ mm		3		Don't count		Minor
06	Bubble			< Φ ≤ 1.00mm		2		Don't count		
	_ *****			1.00mm		0		Don't count		
				quantity		4		Don't count		
				1						
		• G	lass C	Crack:						
		7.1	Cracl	k on the circuit of	electro	le terminal:				
	TI 1 C				¥.					
	The crack of glass					<u>C</u>				
07	giass				×					Minor
				Y						1,11101
				X		Y		Z		
			Fron	$X \le 1/5$	a T	Y≦ 1/2 D		Z≦ t		
			Bacl	k	1	Neglect				
				1		<u>U</u>				



◆Specification:

	pecification:	0.7	
NO	Item	Criterion	Level
		<ul> <li>Glass Crack:</li> <li>7.2 General glass crack and corner edge:</li> <li>7.2.1</li> </ul>	
	The crack of glass	X Y Z	Minor
	X: The length of Crack	Neglect Out A area Neglect	
	Y: The width of crack	7.2.2	
07	Z: The thickness of crack	· · · · · · · · · · · · · · · · · · ·	
	D: terminal length	X Y Neglect Out A area N	Z Teglect
	T: The thickness of glass		
	A: The length of glass	7.3 Glass remain:	
		$\begin{array}{c c} X & Y \\ \hline Neglect & \leq 1/3 \text{ d} \end{array}$	Minor



◆Specification:

NO	ecification : Item	Criterion			Level
07	The crack of glass  X: The length of Crack  Y: The width of crack  Z: The thickness of crack  D: terminal length  T: The thickness of	7.4 Corner cra	ack and medial crack:	X SP	Minor
	glass	X	Y	Z	
	A: The length of	≤1/5a	Crack can't enter viewing area	≤1/2t	
	glass	≤1/5a	Crack can't exceed the half of width of SP width of SP	$1/2t < Z \le 2t$	
		8.1 Backlight c	ean't work normally.		Major
08	Backlight elements	8.2 Backlight o	loesn't light or color is wrong.		Major
00	Ciements	8.3 Illuminatio	n source flickers when lit.		Major
		9.1 pin type mu	ust match type in specification she	et	Major
		9.2 No short ci	rcuits in components on PCB or F	PC	Major
	General	9.3Product pac	kaging must the same as specified	on	36:
09	appearance	packaging	specification sheet.		Major
			g and peeled off in polarizer are no	t	Major
		acceptable			iviajoi
		9.5 The PCB	or FPC between B/L assembled d	istance	M-:-
		(PCB or FF	PC) is $\leq 1.5$ mm		Major



# 4. RELIABILITY TEST

## 4.1 Reliability Test Condition

NO.   TEST ITEM   TEST CONDITION							
Surrounding temperature, then storage at normal condition of the storage at normal con							
Low Temperature Storage Test  Keep in -30 ±2°C 96 hrs Surrounding temperature, then storage at normal conditi  Keep in +60°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal conditi (Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal conditi  Sine wave 10∼55HZ frequency (1 min)  The amplitude of vibration :1.5 mm  Each direction (XYZ) duration for 2 Hrs  Air Discharge:  Apply 6 KV with 5 times Apply 250V with Discharge foreach polarity +/-  Temperature ambinace:15°C ~35°C Humidity relative:30% ~60%  ESD Test  Keep in -30 ±2°C 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or Keep in +40°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition.  Excluding the polarizer)Or  Excluding the polarizer,Or  Excluding the pola							
Surrounding temperature, then storage at normal condition  Keep in +60°C/90%RH duration for 96 hrs Surrounding temperature, then storage at normal condition  High Humidity Storage  High Humidity Storage  High Humidity Storage  Wibration Test  Vibration Test  In Sine wave 10~55HZ frequency (1 min)  The amplitude of vibration :1.5 mm  Each direction (XYZ) duration for 2 Hrs  Air Discharge:  Apply 6 KV with 5 times  Apply 250V with  Discharge foreach polarity +/-  Temperature ambinace:15°C~35°C  Humidity relative:30%~60%  ESD Test  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  (Excluding the polarizer)Or  Keep in +40°C/90%RH duration for 96 hrs  Surrounding temperature, then storage at normal condition  1. Sine wave 10~55HZ frequency (1 min)  2. The amplitude of vibration :1.5 mm  3. Each direction (XYZ) duration for 2 Hrs  Air Discharge:  Apply 250V with 5 times  Ap	on 4hrs						
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High Humidity Storage   (Excluding the polarizer)Or   Keep in +40°C/90%RH duration for 96 hrs   Surrounding temperature, then storage at normal condition							
High Humidity Storage   Keep in +40°C/90%RH duration for 96 hrs     Surrounding temperature, then storage at normal condition     1. Sine wave 10~55HZ frequency (1 min)     2. The amplitude of vibration :1.5 mm     3. Each direction (XYZ) duration for 2 Hrs     Air Discharge:   Contact Discharge     Apply 6 KV with 5 times   Apply 250V with     Discharge foreach polarity +/-   discharge foreach     1. Temperature ambinace:15°C~35°C     2. Humidity relative:30%~60%     5 ESD Test   3. Energy Storage Capacitance(Cs+Cd):150pF±10%	on 4hrs						
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4 Vibration Test  2. The amplitude of vibration :1.5 mm 3. Each direction (XYZ) duration for 2 Hrs  Air Discharge:  Apply 6 KV with 5 times  Apply 250V with  Discharge foreach polarity +/-  1. Temperature ambinace:15°C ~35°C  2. Humidity relative:30% ~60%  5 ESD Test  3. Energy Storage Capacitance(Cs+Cd):150pF±10%	on 4hrs						
2. The amplitude of vibration :1.5 mm  3. Each direction (XYZ) duration for 2 Hrs  Air Discharge:  Apply 6 KV with 5 times  Apply 250V with  Discharge foreach polarity +/-  1. Temperature ambinace:15°C ~35°C  2. Humidity relative:30%~60%  5 ESD Test  3. Energy Storage Capacitance(Cs+Cd):150pF±10%							
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2. Humidity relative: 30% ~ 60% 5 ESD Test 3. Energy Storage Capacitance(Cs+Cd): 150pF±10%	1 3						
5 ESD Test 3. Energy Storage Capacitance(Cs+Cd):150pF±10%							
5. Discharge, mode of operation:							
Single Discharge (time between successive discharges a	least 1 s)						
(Tolerance If the output voltage indication: ±5%)	•						
$-20^{\circ}\text{C} \rightarrow 25^{\circ}\text{C} \rightarrow 70^{\circ}\text{C} \rightarrow 25^{\circ}\text{C}$							
(30mins) (5mins) (5mins)							
6 Temperature Cycling Test  (30mins) (5mins) (30mins) (5mins)  10 Cycle							
Surrounding temperature, then storage at normal conditions	on Ahrs						
1. Sine wave 10~55HZ frequency (1 min)	)11 1111 <i>0</i>						
7 Vibration Test (Packaged)							
2. The amplitude of vioration :1.5 mm							
3. Each direction (XYZ) duration for 2 Hrs							
Packing Weight (Kg)   Drop Height (cm)							
0 ~ 45.4							
45.4 ~ 90.8							
8 Drop Test (Packaged) 90.8 ~ 454 61	7						
Over 454 46	-						
Drop direction: **3 comer /1 edges /6 sides etc	ph Itimas						



#### 5. PRECAUTION RELATING PRODUCT HANDLING

#### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### **5.2 HANDLING**

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

#### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}$ C  $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

#### **5.4 TERMS OF WARRANTY**

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

#### 5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



# 6. PACKING Specification

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POWERTIP TECH. CORP.